

Title (en)

PROCESS FOR PRODUCING A BASE MOULD FOR ELECTROLYCALLY PRODUCING SEAMLESS ROTARY SCREEN PRINTING STENCILS, IN PARTICULAR OF NICKEL

Title (de)

VERFAHREN ZUR HERSTELLUNG EINER MUTTERMATRIZE FÜR DIE GALVANISCHE ERZEUGUNG VON NAHTLOSEN ROTATIONS-SIEBDRUCKSCHABLONEN, INSbesondere AUS NICKEL

Title (fr)

PROCEDE POUR LA FABRICATION D'UNE MATRICE DE BASE POUR LA PRODUCTION ELECTROLYTIQUE DE POCHOIRS ROTATIFS, SANS SOUDURE, PRINCIPALEMENT EN NICKEL

Publication

**EP 0694088 B1 19990519 (DE)**

Application

**EP 95908917 A 19950209**

Priority

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Abstract (en)

[origin: US5972194A] PCT No. PCT/EP95/00458 Sec. 371 Date Sep. 20, 1996 Sec. 102(e) Date Sep. 20, 1996 PCT Filed Feb. 9, 1995 PCT Pub. No. WO95/21951 PCT Pub. Date Aug. 17, 1995A process for producing a mold for electrolytically producing seamless rotary screen printing stencils is disclosed which includes the steps of: providing a metal mold body having a cylindrical outer surface; covering the outer surface with a sensitive layer such as a photo-sensitive layer, a thermo-sensitive layer or an electrically sensitive layer; exposing predetermined portions of the sensitive layer to a beam which is controlled electronically thereby creating exposed portions of the sensitive layer as well as unexposed portions of the sensitive layer; removing the unexposed portions of the sensitive layer; generating indentations in the metal body at locations where the unexposed portions of the sensitive layer have just been removed; removing the exposed portions of the sensitive layer; and filling the indentations with a non-conductive filler.

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